

Gallium Arsenide Schottky Rectifier

Second generation ISOPLUS220™ Electrically Isolated Back Surface

Preliminary Data

 V_{RRM} = 600 V (2x300V) I_{DC} = 11 A $C_{Junction}$ = 4 pF

Туре	Marking on product	Circuit	Package	
DGSS 6-06CC	DGSS 6-06CC		ISOPLUS220A	

Diode					
Symbol	Conditions	Maximum Ratings			
V _{RRM/RSM}	(between terminal 1 and 3)	600 300	V V		
I _{FAV}	$T_C = 25$ °C; DC $T_C = 90$ °C; DC	11 6	A A		
I _{FSM}	$T_{VJ} = 45^{\circ}C; t_p = 10 \text{ ms (50 Hz), sine}$	30	Α		
P _{tot}	T _C = 25°C	12	W		

Symbol	Conditions		 acteris typ.	tic Va ∣max.	lues
V _F	• •	$T_{VJ} = 25$ °C $T_{VJ} = 125$ °C	1.7 1.2	2.1	V
I _R		$T_{VJ} = 25$ °C $T_{VJ} = 125$ °C	15	0.15	mΑ μΑ
I _{RM}	$ \begin{cases} I_F = 2 \text{ A}; \\ V_R = 150 \text{ V}; \end{cases} $	-di _F /dt = 150 A/ μ s; T _{VJ} = 125°C	0.6 20		A ns
C¹	V _R = 150 V;	$T_{VJ} = 125^{\circ}C$	4		pF
R _{thJC}				12.5	K/W

Data according to IEC 60747 and per diode unless otherwise specified

Features

GaAs Schottky Diode with Enhanced Barrier Height:

- lowest operating forward voltage drop due to additional injection of minority carriers
- high switching speed
 - low junction capacity of GaAs diode independent from temperature
- short and low reverse recovery current peak due to short lifetime of minority carriers
- soft turn off
- low leakage current ISOPLUS220™ Package:
- isolated back surface
- low coupling capacy between pins and heatsink
- enlarged creepage
- high reliability
- industry standard outline

Applications

Power Factor Correction (PFC) Switched Mode Power Supplies:

- AC-DC converters
- DC-DC converters
- high switching frequency
- · high efficiency
- low EMI

for use e. g. in:

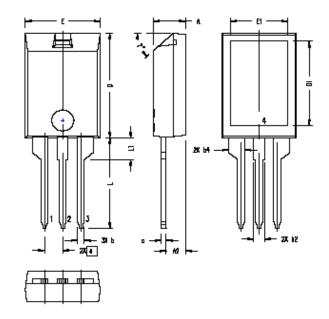
- telecom
- computer
- automotive equipment



Component					
Symbol	Conditions	Maximum Rating			
I _{RMS}	per pin	45	Α		
T _{VJ}		-55+175 -55+150	°C		
V _{ISOL}	I _{ISOL} ≤ 1 mA; 50/60 Hz	2500	٧~		
F _c	mounting force with clip	1050	N		

Symbol	Conditions	Characteristic Values min. typ. max.		
C _p	coupling capacity between shorted pins and mounting tab in the case		15	pF
R _{thCS}			0.3	K/W
Weight			2	g

ISOPLUS220 OUTLINE



SYM	INCHES		MILLIMETERS		
31M	MIN	MAX	MIN	MAX	
A	.157	.197	4.00	5.00	
A2	.098	.118	2.50	3.00	
b	.D35	.D51	0.90	1,30	
b2	.049	.065	1,25	1,65	
ь4	.093	.100	2.35	2.55	
С	BS0.	.039	0.70	1.00	
D	.591	.630	15.DD	16.00	
D1	.472	.512	12.00	13.00	
Ε	.394	.433	10.00	11.00	
E1	.295	.335	7.50	8.50	
e	.10D BASIC		2.55 BASIC		
L	.512	.571	13.00	14.50	
L1	.118	.138	3.00	3.50	
T.			42.5"	47.5"	

NOTE:

- Bottom heatsink (Fin 4) is electrically isolated from Pin 1, 2, or 3.
 This drawing will meet dimensional requirement of JEDEC SS Product Cuttine TO-273 except D and D1 dimension.